

REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD

**NOTES:**

**ELECTRICAL:**

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

**MECHANICAL:**

1. SHIELD MATERIAL : BRASS C2680 t=0.25mm.
2. HOUSING MATERIAL : FR52
3. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
4. PLATING : SHIELD PLATED Sn/Pb OVER NICKEL.  
: CONTACT GOLD PLATING OVER NICKEL.
5. OPERATING LIFE : 750 CYCLES MIN.
6. PCB RETENTION PRE-SOLDER : 1 LB MIN.
7. PCB RETENTION POST-SOLDER: 10 LBS MIN.

**ENVIRONMENTAL:**

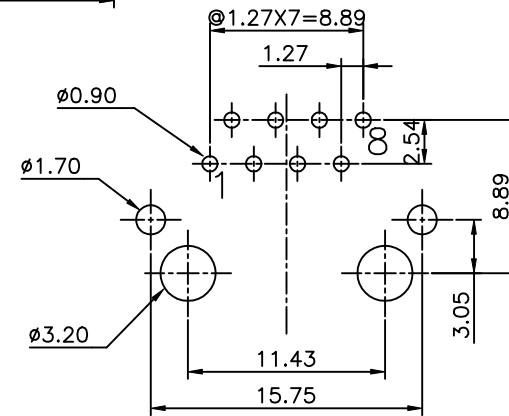
1. STORAGE : -40°C TO +85°C.
2. OPERATION: -40°C TO +85°C.
3. WAVE SOLDER TEMPERATURE: 255°C TO 265°C 5~10 SECOND.

MATES WITH MODULAR PLUG CONFORMING TO  
FCC PART 68, SUBPART F.

CUL FILE NO. E163191

ROHS P/N: E5288-XX0B4X-L

R3-TIN	1- 3u"	2- 6u"
RY-NICKEL	3-15u"	4-30u"
R4-W/ Nickel,Tinned Solder Tab	5-50u"	



PC Board Layout

DETACHED LISTS	MM (INCH)		DFTO ANKUE	DATE 6/17/2005	<b>FULL RISE ELECTRONIC CO., LTD</b>  TITLE (DIP & IMPROVED TYPE) <b>RJ45 TOP ENTRY PCB JACK</b>
	TOLERANCES EXCEPT AS NOTED		CHKD YICAN	DATE 2005/06/18	
			MFO	DATE	
			APPV LUSHENG	DATE 2005/06/18	
.0 ± 0.2		±	MATERIAL :		DRAWING NO. GE523096-LA
.00 ± 0.15		±	QT'Y :		
.000 ± 0.075		±	FINISH :		REV 0
ANGLES ± 0.5		THIRD ANGLE PROJECTION		SCALE : 3:1	DO NOT SCALE DRAWING
					SHEET 1 OF